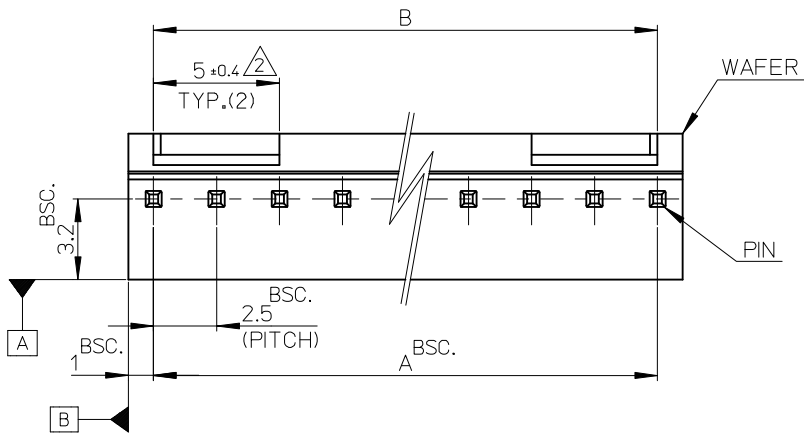
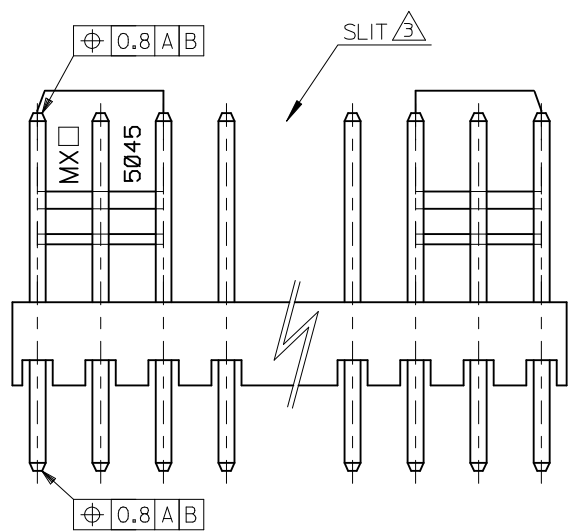


基板取付穴推奨寸法
RECOMMENDED P.C.BOARD HOLE DIM.



注)
NOTE.

1. 材料

MATERIAL

ピン : 0.635×14.2 黄銅、ニッケル下地金メッキ
PIN: 0.635×14.2 BRASS Au OVER NICKEL PLATING.
ウェハー: ポリアミド, UL94V-0
WAFER: POLYAMIDE, UL94V-0

2 6極以上に適用

TO BE APPLIED FOR 6 CKT. AND MORE THEN 6 CKT.

3 5極以下はロック部スリットなし

NO SLIT IS PROVIDED FOR 5 CKT. AND LESS THAN 5 CKT.

4. ELV 及び RoHS 適合品

ELV AND RoHS COMPLIANT

	1.35	0.85	47.5 ^{+0.3} _{-0.45}	47.5	22 11 1201	20
↑			45 ^{+0.3} _{-0.45}	45	1191	19
			42.5 ^{+0.3} _{-0.45}	42.5	1181	18
			40 ^{+0.3} _{-0.45}	40	1171	17
			37.5 ^{+0.3} _{-0.45}	37.5	1161	16
			35 ^{+0.3} _{-0.45}	35	1151	15
			32.5 ^{+0.25} _{-0.4}	32.5	1141	14
			30 ^{+0.25} _{-0.4}	30	1131	13
			27.5 ^{+0.25} _{-0.4}	27.5	1121	12
			25 ^{+0.2} _{-0.4}	25	1111	11
			22.5 ^{+0.2} _{-0.4}	22.5	1101	10
			20 ^{+0.15} _{-0.35}	20	1091	9
			17.5 ^{+0.15} _{-0.35}	17.5	1081	8
			15 ^{+0.1} _{-0.3}	15	1071	7
			12.5 ^{+0.1} _{-0.3}	12.5	1061	6
↓			10 ^{+0.1} _{-0.3}	10	1051	5
1.35	0.85	7.5 ^{+0.1} _{-0.3}	7.5		1041	4
1.2	I	5 ^{+0.1} _{-0.3}	5		1031	3
1.2	I	2.5 ^{+0.1} _{-0.3}	2.5	22 11 1021		2
D	C	B	A	ORDER No. 極数 CKT.		

MODEL No. : 5045-**AG

REDRAWN & REVISED EC NO: J2014-0920 DRAWN: HORI 2013/11/25 CHKD: KASAKAWA 2013/11/28 APPR: NUKITA 2013/11/28	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	MODEL NO.: SD-5045-001		
				MM ONLY		5:1	METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY Y. MIZUNO	DATE 1990/03/23	TITLE KK2.5 WAFER ASSY WITH LOCK ENGLISH ONLY				
		10 OVER 30 UNDER	± 0.25	CHECKED BY	DATE					
		30 OVER	± 0.3	APPROVED BY M. ENOMOTO	DATE 1991/12/10	DOCUMENT NO. molex SD-5045-001				
		ANGULAR ± 3 °		MATERIAL NO.						
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SHEET NO. 1 OF 1					
REV				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

molex

SHEET NO.
1 OF 1